

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JUN 30 2008

Application No.: 10/647,297      Group Art Unit: 1794  
 Filing Date: August 26, 2003      Examiner: Hai Vo  
 Applicants: Hyun HUH et al.  
 Title: POLISHING PAD CONTAINING EMBEDDED LIQUID MICROELEMENTS AND METHOD OF MANUFACTURING THE SAME  
 Attorney Docket: 47881-000003/US

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June 30, 2008

**SUPPLEMENTAL AMENDMENT UNDER 37 C.F.R. § 1.116**

Sir:

In response to the Advisory Action mailed June 4, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended three (3) months to July 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

**Amendments to the Claims** begins on page 2 of this Amendment.

**Remarks** begin on page 5 of this Amendment.

	<b>Claims remaining after Amendment</b>		<b>Highest number previously paid for</b>		<b>Present extra</b>
<b>Total</b>	14	-	31	=	0
<b>Independent</b>	1	-	3	=	0